

2SC5658 / 2SC4617EB / 2SC4617 2SC4081UB / 2SC4081 / 2SC2412K

General purpose small signal amplifier (50V, 150mA)

Datasheet

Parameter	Value
V _{CEO}	50V
I _C	150mA

Features

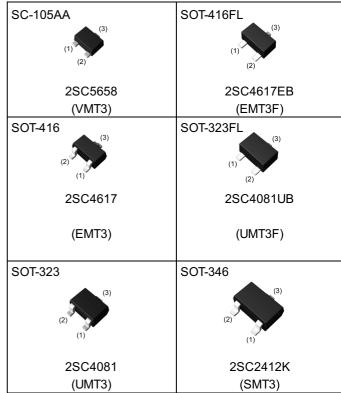
1)Low Cob.Cob=2.0pF(Typ.)

2)Complements the 2SA2029/ 2SA1774EB/2SA1774/2SA1576UB/ 2SA1576A/2SA1037AK.

Application

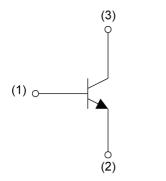
GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Outline



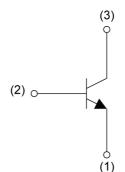
•Inner circuit

2SC5658/2SC4617EB/2SC4081UB



- (1) Base
- (2) Emitter
- (3) Collector

2SC4617/2SC4081/2SC2412K



- (1) Emitter
- (2) Base
- (3) Collector

Packaging specifications

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Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	hFE rank	Marking
2SC5658	SC-105AA	1212	T2L	180	8	8000	QRS	В
2SC4617EB	SOT-416FL	1616	TL	180	8	3000	QRS	В
2SC4617	SOT-416	1616	TL	180	8	3000	QRS	В
2SC4081UB	SOT-323FL	2021	TL	180	8	3000	QRS	В
2SC4081	SOT-323	2021	T106	180	8	3000	QRS	В
2SC2412K	SOT-346	2928	T146	180	8	3000	QRS	В

● Absolute maximum ratings (T_a = 25°C)

F	Parameter	Symbol	Values	Unit	
Collector-base voltage		V_{CBO}	60	V	
Collector-emitter voltage		V _{CEO}	50	V	
Emitter-base voltage		V _{EBO}	7	V	
		I _C	150	mA	
Collector current		I _{CP} *1	$\begin{array}{c cccc} V_{CBO} & 60 \\ \hline V_{CEO} & 50 \\ \hline V_{EBO} & 7 \\ \hline I_{C} & 150 \\ \hline I_{CP}^{*1} & 200 \\ \hline & 150 \\ \hline & 150 \\ \hline & 150 \\ \hline & 200 \\ \hline & 200 \\ \hline & 200 \\ \hline & T_{j} & 150 \\ \hline \end{array}$	mA	
	2SC5658		150		
	2SC4617EB		150		
Davier dia sin etia e	2SC4617	D *2	150	\^/	
Power dissipation	2SC4081UB	P _D -	200	mW	
	2SC4081		200		
	2SC2412K		200		
Junction temperature		T _j	150	°C	
Range of storage tempera	ature	T _{stg}	-55 to +150	°C	

● Electrical characteristics (T_a = 25°C)

Darameter	Symbol Conditions		Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	60	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	-	-	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	7	1	1	V
Collector cut-off current	I _{CBO}	V _{CB} = 60V	1	1	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 7V	-	-	100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 50$ mA, $I_B = 5$ mA	-	-	400	mV
DC current gain	h _{FE}	V_{CE} = 6V, I_{C} = 1mA	120	1	560	-
Transition frequency	f _T	$V_{CE} = 12V, I_{E} = -2mA,$ f = 100MHz	-	180	-	MHz
Output capacitance	C_{ob}	$V_{CB} = 12V$, $I_E = 0A$, $f = 1MHz$	-	2.0	3.5	pF

hFE values are calssified as follows:

rank	Q	R	S	-	-
h _{FE}	120-270	180-390	270-560	-	-

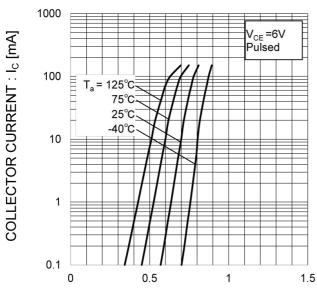
^{*1} Pw=1ms, Single Pulse.



^{*2} Each terminal mounted on a reference land.

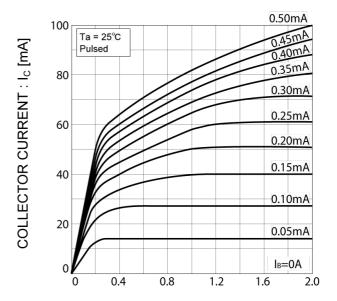
● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE: VBE [V]

Fig.2 Grounded Emitter Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

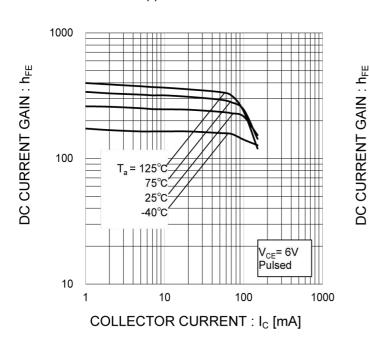
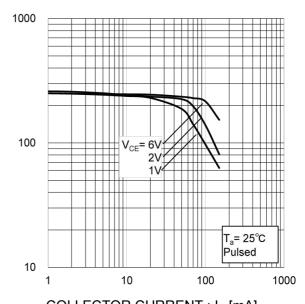


Fig.4 DC Current Gain vs. Collector Current (II)



COLLECTOR CURRENT : I_C [mA]

● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

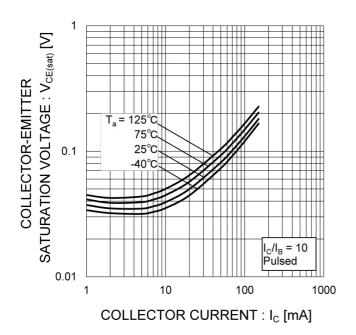


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

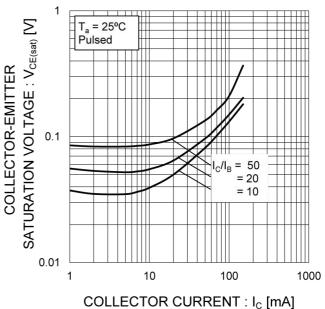


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current (I)

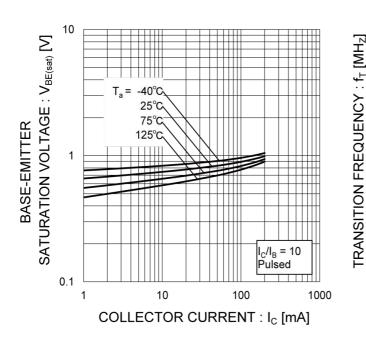
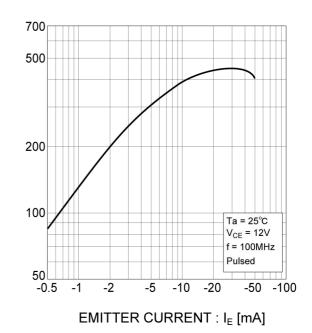


Fig.8 Gain Bandwith Product vs.
Emitter Current



● Electrical characteristic curves(T_a = 25°C)

Fig.9 Collector Output Capacitance vs.
Collector-Base Voltage
Emitter Input Capacitance vs.
Emitter-Base Voltage

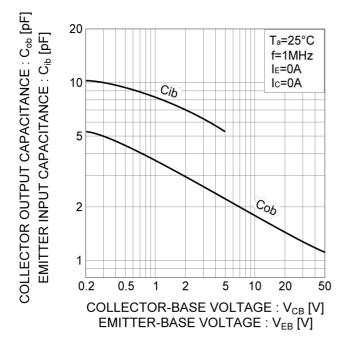


Fig.10 Safe Operating Area

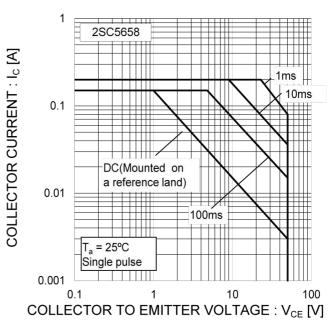


Fig.11 Safe Operating Area

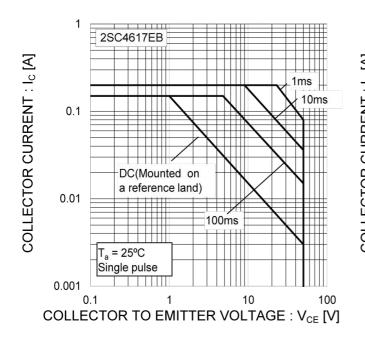
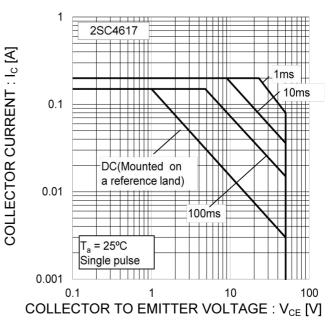


Fig.12 Safe Operating Area



● Electrical characteristic curves(Ta=25°C)

Fig.13 Safe Operating Area

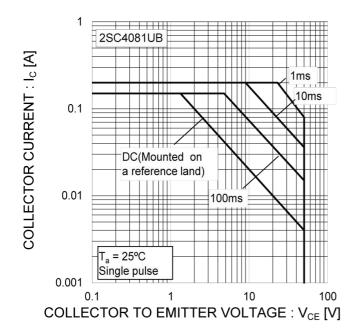


Fig.14 Safe Operating Area

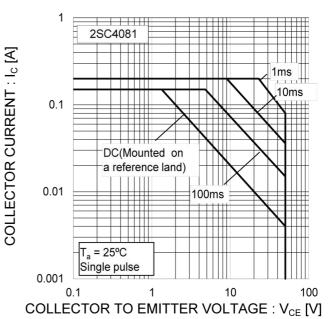
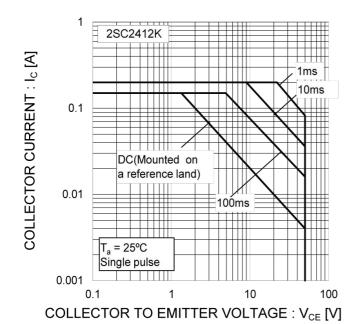
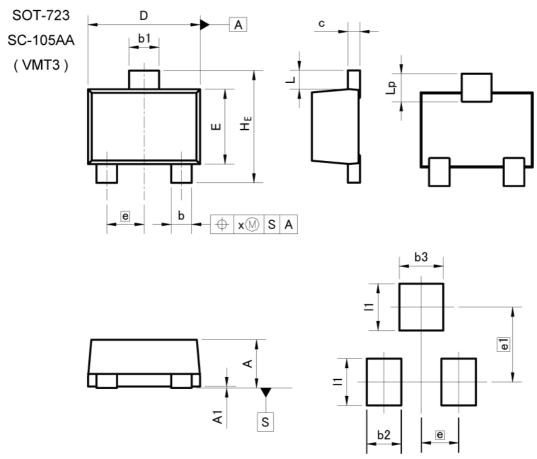


Fig.15 Safe Operating Area







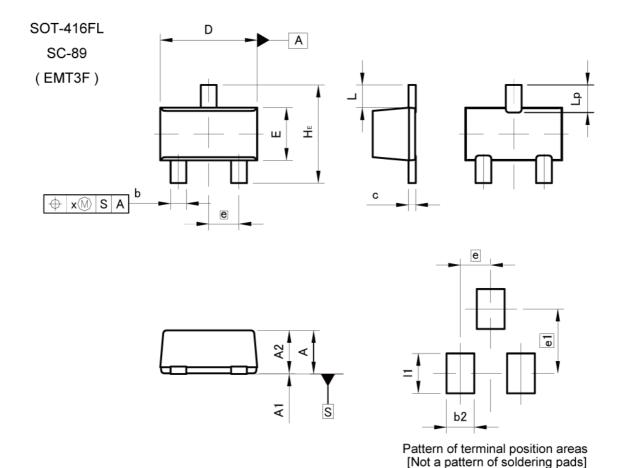
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
e 0.40		40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	=	0.10	<u> </u>	0.004

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
b2	<u> </u>	0.37	544	0.015
b3	223	0.47	922	0.019
e1	0.80		0.0	031
11	5 98	0.50	250	0.020

Dimension in mm/inches



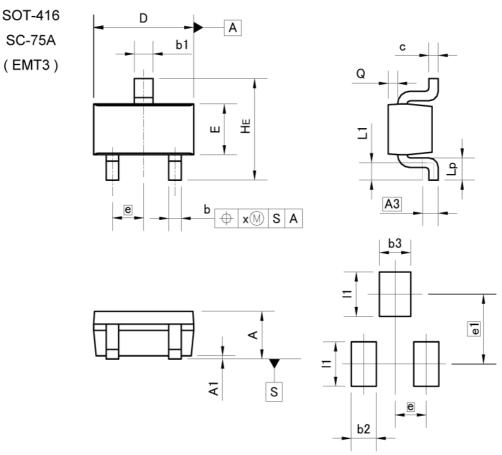


MILIMETERS INCHES DIM MIN MAX MIN MAX 0.85 0.033 A 0.65 0.026 A1 0.00 0.10 0.000 0.004 A2 0.60 0.80 0.024 0.031 b 0.21 0.36 0.008 0.014 0.003 0.007 0.08 0.18 C D 1.50 1.70 0.059 0.067 0.76 0.96 0.030 E 0.038 0.50 0.020 е HE 1.50 1.70 0.059 0.067 0.37 0.015 L 0.35 0.55 0.014 0.022 Lp 0.10 0.004 X

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	= 1	0.46	_	0.018
e1	4 :	1.05	-	0.041
11	=	0.65	=	0.026

Dimension in mm/inches





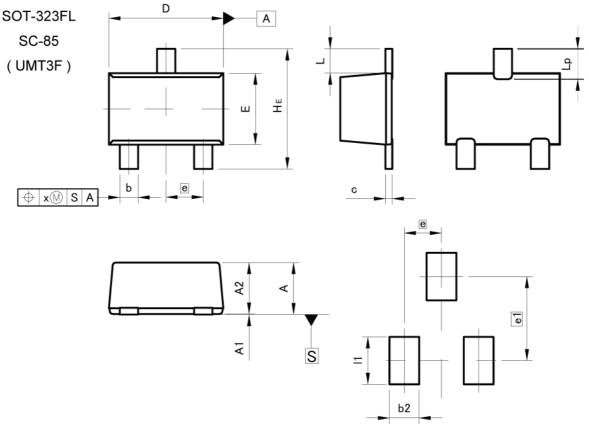
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.50		0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	<u>≠</u> 3	0.004	8 11
Lp	0.15		0.006	255
Q	0.05	0.25	0.002	0.010
х	9.7	0.10		0.004

DIM	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 48	0.50	; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; 	0.020
e1	1.10		0.0	043
11		0.70	-	0.028

Dimension in mm/inches





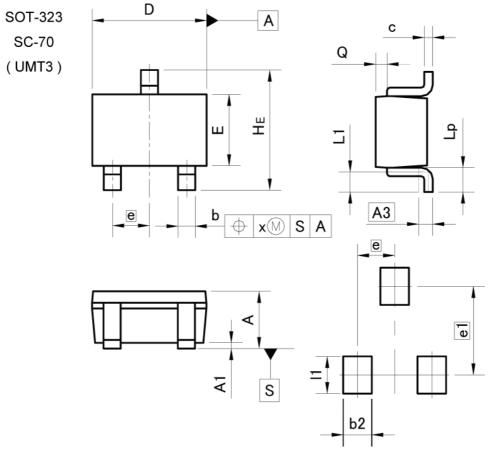
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	0.65 0.02		26
HE	2.00	2.20	0.079	0.087
L	0.43		0.0	17
Lp	0.43	0.63	0.017	0.025
х		0.10	-	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	=1	0.52	-	0.020
e1	1.47		0.0	058
11	=	0.83		0.033

Dimension in mm/inches





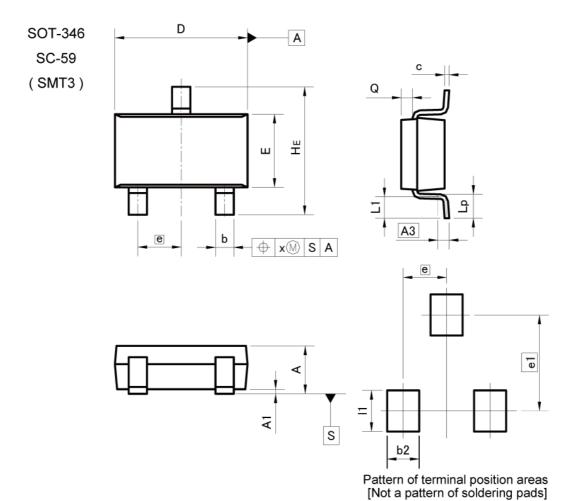
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0	0.004	
A3	0.25		0.01		
b	0.25	0.40	0.01	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.65		0.03		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.02	
Lp	0.25	0.55	0.01	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	_	0.004	

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	S	0.50	-	0.02
11	_	0.65	_	0.026

Dimension in mm/inches





DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	7,8	0.10	\$ 5	0.004
У	=0	0.10	97	0.004

DIM	MILIMETERS		INCHES	
DIW	MIN	MAX	MIN	MAX
b2	-2	0.60	× -	0.024
e1	2.10		0.083	
11		0.90		0.035

Dimension in mm/inches



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